Tyrone Camarero Specifications



Camarero SS4C0TR-34

Key features

- Single socket H4 (LGA 1151) supports, Intel® Xeon® processor E3-1200 v5, Intel® 6th Gen. Core™ i3 series,Intel® Celeron® and Intel® Pentium®
- Intel® C236 chipset
- Up to 64GB Unbuffered ECC UDIMM DDR4 2133MHz; 4x DIMM slots
- 1 PCI-E 3.0 x8 (in x16), 1 PCI-E 3.0 x8,1 PCI-E 3.0 x4 (in x8)
- Dual GbE LAN with Intel® i210-AT
- 8x SATA3 (6Gbps) via C236; RAID 0, 1, 5, 10
- I/O: 1x VGA, 2x COM, 2x SuperDOM, and TPM header
- 5x USB 3.0 (2 rear + 2 via header + 1 Type A), 6x USB 2.0 (2 rear + 4 via headers)
- Integrated IPMI 2.0 and KVM with Dedicated LAN
- 2x 5.25" external drive bays,4x 3.5" internal drive bays,1x 3.5" external drive bay (OEM)
- 300W High-efficiency Power Supply







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Single socket H4 (LGA 1151) supports Processor

Intel® Xeon® processor E3-1200 v5,Intel® 6th Gen. Core™ i3 series,Intel® Celeron®

and Intel® Pentium®

Chipset

Chipset Intel® C236 chipset

System Memory

Memory Capacity 64GB Unbuffered ECC UDIMM,

DDR4-2133MHz, in 4 DIMM slots

Expansion Slots

PCI Express 1 PCI-E 3.0 x8 (in x16), 1 PCI-E 3.0 x8,

1 PCI-E 3.0 x4 (in x8)

Integrated On-Board

SATA Intel® C236 controller for 8 SATA3

(6Gbps) ports; RAID 0,1,5,10

Add-on Options

Raid Card Optional

Optical Drive

Front Panel

Led's Power LED, Hard drive activity LED,

Network activity LED, System Overheat LED

Buttons Power On/Off button,

Drive Bays

4x 3.5" tool-less HDD trays, SAS or enterprise HDD bays

SATA HDD only recommended,2x 5.25" external drive bays,1x 3.5" external drive bay

(OEM option)

Power Supply

300W High-efficiency Power Supply

Cooling System

1x 9cm (rear) PWM fan w/ tool-less design.

1x 8cm (front) cooling fan (optional).

Optimized Cooling Technology at 25dB Whisper-Quiet

Operation

Form Factor

Form Factor Mid Tower

Width: 7.25" (184 mm), 14.25" (362 mm), Height: Depth: 16.75" (425 mm

Email: info@tyronesystems.com

For more/current product information, visit

www.tyronesystems.com

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